

INTERCONNECTS

SERIES 335, 364, 435, 464 • 2,54 GRID (0,46 DIA. PINS), LOW PROFILE • SINGLE AND DOUBLE ROW STRIPS

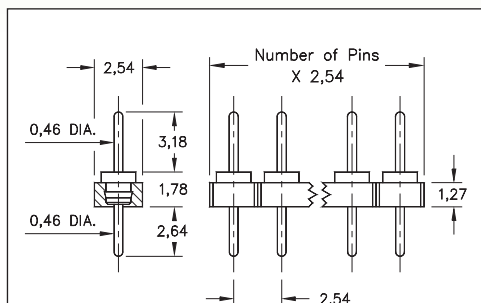


FIG. 1

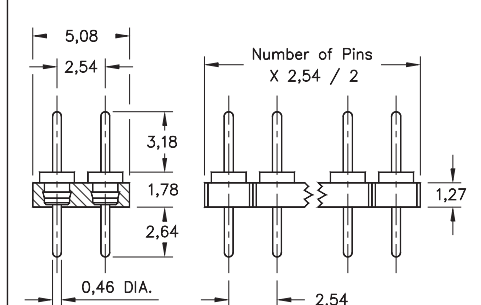


FIG. 2

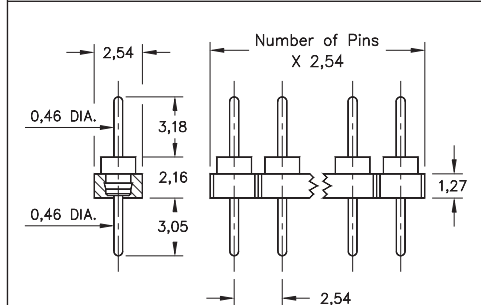


FIG. 3

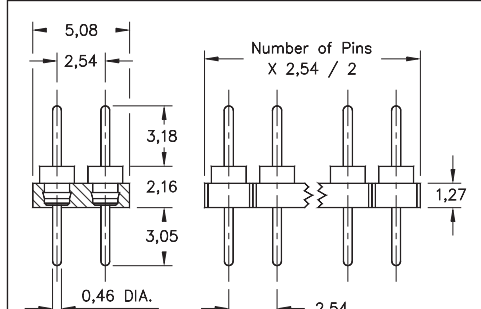


FIG. 4

- Series 335 and 435 single and double row PCB interconnects offer a 1,78 profile, the lowest available
- Series 364 and 464 single and double row PCB interconnects offer 2,16 profile above board
- Series 335 and 435 use MM #3516 pins. See page 212 for details
- Series 364 and 464 use MM #6458 pins. See page 213 for details
- Insulators are high temperature thermoplastic, suitable for all soldering operations



ORDERING INFORMATION

FIG. 1	Series 335...160	Single Row 1,78 Profile Pin Header										
	335-XX-1-00-160000 Specify number of pins 01-32											
FIG. 2	Series 435...160	Double Row 1,78 Profile Pin Header										
	435-XX-2-00-160000 Specify number of pins 04-72											
FIG. 3	Series 364...580	Single Row 2,16 Profile Pin Header										
	364-10-1-00-580000 Specify number of pins 01-32											
FIG. 4	Series 464...580	Double Row 2,16 Profile Pin Header										
	464-10-2-00-580000 Specify number of pins 04-72											
RoHS-2 2011/65/EU XX=Plating Code See Below For Electrical, Mechanical & Environmental Data, See page 264 <table><tr><td>SPECIFY PLATING CODE XX=</td><td>10 </td><td>90</td><td>40 </td><td></td></tr><tr><td>Pin Plating </td><td>0,25µm Au</td><td>5,08µm Sn/Pb</td><td>5,08µm Sn</td><td></td></tr></table>			SPECIFY PLATING CODE XX=	10	90	40		Pin Plating	0,25µm Au	5,08µm Sn/Pb	5,08µm Sn	
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